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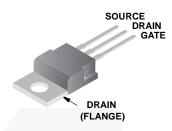


Data Sheet October 2013

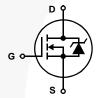
# N-Channel Logic Level UltraFET Power MOSFET 60 V, 33 A, 35 m $\Omega$

# **Packaging**

#### **JEDEC TO-220AB**



# Symbol



**Absolute Maximum Ratings** T<sub>C</sub> = 25°C, Unless Otherwise Specified

#### Features

- Ultra Low On-Resistance
  - $r_{DS(ON)} = 0.030\Omega$ ,  $V_{GS} = 10V$
  - $r_{DS(ON)} = 0.035\Omega, V_{GS} = 5V$
- Simulation Models
  - Temperature Compensated PSPICE® and SABER™ Electrical Models
  - Spice and SABER Thermal Impedance Models
  - www.fairchildsemi.com
- · Peak Current vs Pulse Width Curve
- UIS Rating Curve
- · Switching Time vs RGS Curves

# Ordering Information

PART NUMBER	PACKAGE	BRAND
HUF76423P3	TO-220AB	76423P

HUF76423P3

300

260

Drain to Source Voltage (Note 1)V <sub>DSS</sub>	60	V
Drain to Gate Voltage ( $R_{GS} = 20k\Omega$ ) (Note 1)	60	V
Gate to Source Voltage	±16	V
Drain Current		
Continuous ( $T_C = 25^{\circ}C$ , $V_{GS} = 5V$ )	33	Α
Continuous (T <sub>C</sub> = 25 <sup>0</sup> C, V <sub>GS</sub> = 10V) (Figure 2)	35	Α
Continuous ( $T_C$ = 100°C, $V_{GS}$ = 5V)	23	Α
Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, V <sub>GS</sub> = 4.5V) (Figure 2)	22	Α
Pulsed Drain Current	Figure 4	
Pulsed Avalanche RatingUIS	Figures 6, 17, 18	
Power Dissipation	85	W
Derate Above 25°C	0.567	W/oC
Operating and Storage Temperature	-55 to 175	°C

NOTES: 1.  $T_{.1} = 25^{\circ}\text{C}$  to  $150^{\circ}\text{C}$ .

Maximum Temperature for Soldering

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Product reliability information can be found at http://www.fairchildsemi.com/products/discrete/reliability/index.html For severe environments, see our Automotive HUFA series.

All Fairchild semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

UNITS

# HUF76423P3

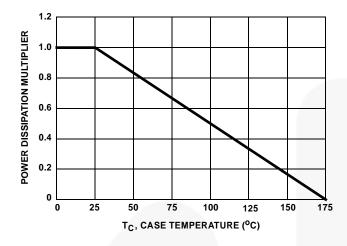
# **Electrical Specifications** $T_C = 25^{\circ}C$ , Unless Otherwise Specified

OFF STATE SPECIFICATIONS  Drain to Source Breakdown Voltage  Zero Gate Voltage Drain Current  Gate to Source Leakage Current  ON STATE SPECIFICATIONS	BV <sub>DSS</sub> I <sub>DSS</sub>	$V_{DS} = 55V, V_{GS} = 0V$ $V_{DS} = 50V, V_{GS} = 0V$	/ , T <sub>C</sub> = -40 <sup>o</sup> C (Figure 12)	60 55	-	-	V
Zero Gate Voltage Drain Current  Gate to Source Leakage Current	I <sub>DSS</sub>	$I_D = 250\mu A$ , $V_{GS} = 0V_{DS} = 55V$ , $V_{GS} = 0V_{DS} = 50V$ , $V_{GS} = 0V_{DS} = 50V$ , $V_{GS} = 0V_{DS} = 50V$	/ , T <sub>C</sub> = -40 <sup>o</sup> C (Figure 12)		-	-	V
Gate to Source Leakage Current	_	$V_{DS} = 55V, V_{GS} = 0V$ $V_{DS} = 50V, V_{GS} = 0V$		55	_		
Gate to Source Leakage Current	_	$V_{DS} = 50V, V_{GS} = 0V$	/		_	-	V
	I <sub>GSS</sub>			-	-	1	μΑ
	I <sub>GSS</sub>		$V_{DS} = 50V, V_{GS} = 0V, T_{C} = 150^{\circ}C$		-	250	μΑ
ON STATE SPECIFICATIONS		$V_{GS} = \pm 16V$	V <sub>GS</sub> = ±16V		-	±100	nA
Gate to Source Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$ , $I_D = 250\mu A$ (Figure 11)		1	-	3	V
Drain to Source On Resistance	r <sub>DS(ON)</sub>	I <sub>D</sub> = 35A, V <sub>GS</sub> = 10V (Figures 9, 10)		-	0.025	0.030	Ω
	-(- /	$I_D = 23A, V_{GS} = 5V$ (	Figure 9)	-	0.029	0.035	Ω
		I <sub>D</sub> = 22A, V <sub>GS</sub> = 4.5V	(Figure 9)	-	0.032	0.038	Ω
THERMAL SPECIFICATIONS					-		
Thermal Resistance Junction to Case	$R_{\theta JC}$	TO-220		-	-	1.76	oC/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$			-	-	62	°C/W
SWITCHING SPECIFICATIONS (VGS =	= 4.5V)						
Turn-On Time	ton	V <sub>DD</sub> = 30V, I <sub>D</sub> = 22A	-	-	245	ns	
Turn-On Delay Time	t <sub>d</sub> (ON)	$V_{GS} = 4.5V, R_{GS} = 10\Omega$ (Figures 15, 21, 22)		-	12	-	ns
Rise Time	t <sub>r</sub>			-	147	-	ns
Turn-Off Delay Time	t <sub>d</sub> (OFF)			-	32	-	ns
Fall Time	t <sub>f</sub>			-	50	-	ns
Turn-Off Time	tOFF			-	-	125	ns
SWITCHING SPECIFICATIONS (VGS =	= 10V)						
Turn-On Time	ton	V <sub>DD</sub> = 30V, I <sub>D</sub> = 35A	-	-	140	ns	
Turn-On Delay Time	t <sub>d</sub> (ON)	$V_{GS} = 10V,$		-	7	-	ns
Rise Time	t <sub>r</sub>	$R_{GS} = 10\Omega$ (Figures 16, 21, 22)	-	85	-	ns	
Turn-Off Delay Time	t <sub>d(OFF)</sub>			-	47	-	ns
Fall Time	t <sub>f</sub>			/ -	76	-	ns
Turn-Off Time	tOFF			/ -	-	185	ns
GATE CHARGE SPECIFICATIONS							
Total Gate Charge	Q <sub>g(TOT)</sub>	V <sub>GS</sub> = 0V to 10V	V <sub>DD</sub> = 30V,	-	28	34	nC
Gate Charge at 5V	Q <sub>g(5)</sub>	$V_{GS} = 0V \text{ to } 5V$ $V_{GS} = 0V \text{ to } 1V$ $I_{D} = 23A,$ $I_{g(REF)} = 1.0\text{mA}$ (Figures 14, 19, 20)	-	15	18	nC	
Threshold Gate Charge	Q <sub>g(TH)</sub>		-	1.2	1.5	nC	
Gate to Source Gate Charge	Q <sub>gs</sub>	(Figures 14, 15, 20)		-	3.5	-	nC
Gate to Drain "Miller" Charge	Q <sub>gd</sub>			-	7	-	nC
CAPACITANCE SPECIFICATIONS		1					
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V	<i>'</i> ,	-	1060	-	pF
Output Capacitance	C <sub>OSS</sub>	f = 1MHz		-	315	-	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	(Figure 13)		-	65	-	pF

# **Source to Drain Diode Specifications**

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage	$V_{SD}$	I <sub>SD</sub> = 23A	-	-	1.25	V
		I <sub>SD</sub> = 11.5A	-	-	1.0	V
Reverse Recovery Time	t <sub>rr</sub>	$I_{SD} = 23A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	80	ns
Reverse Recovered Charge	Q <sub>RR</sub>	$I_{SD} = 23A$ , $dI_{SD}/dt = 100A/\mu s$	=	-	205	nC

# **Typical Performance Curves**



40 40 30 V<sub>GS</sub> = 10V V<sub>GS</sub> = 4.5V V<sub>GS</sub> = 4.5V T<sub>C</sub>, CASE TEMPERATURE (°C)

FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

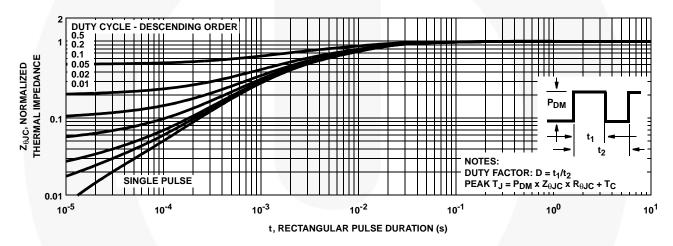
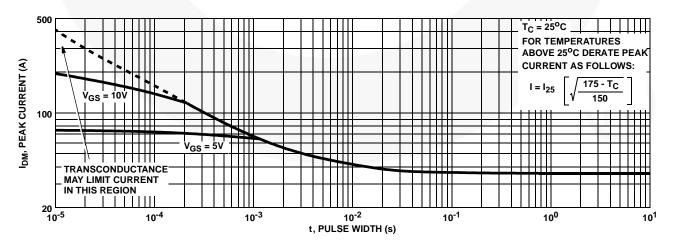


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE



**FIGURE 4. PEAK CURRENT CAPABILITY** 

# Typical Performance Curves (Continued)

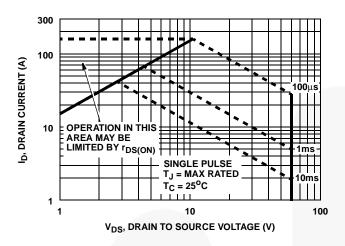


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA

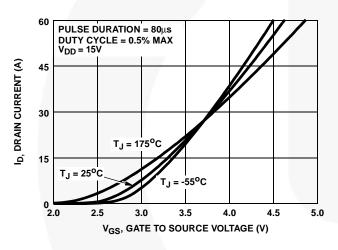


FIGURE 7. TRANSFER CHARACTERISTICS

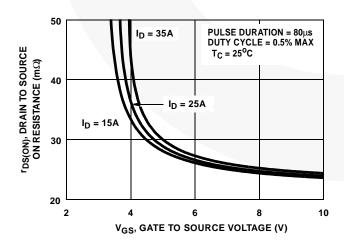
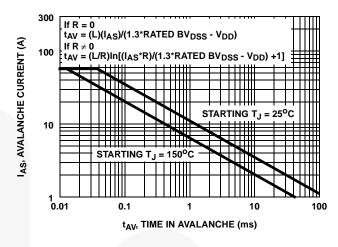


FIGURE 9. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT



NOTE: Refer to Fairchild Application Notes AN9321 and AN9322.

FIGURE 6. UNCLAMPED INDUCTIVE SWITCHING CAPABILITY

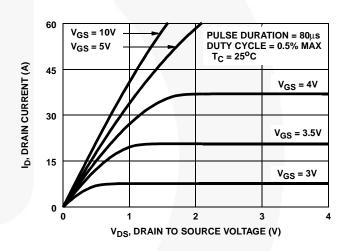


FIGURE 8. SATURATION CHARACTERISTICS

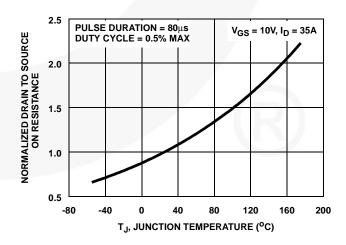


FIGURE 10. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

# Typical Performance Curves (Continued)

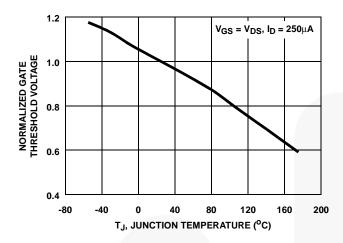


FIGURE 11. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

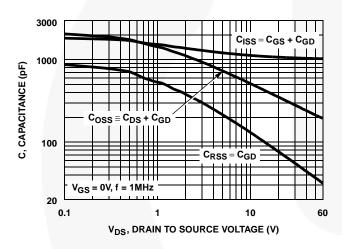


FIGURE 13. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE

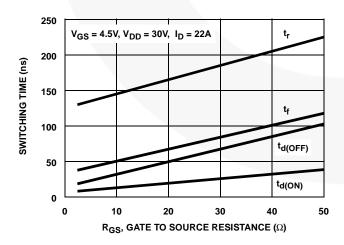


FIGURE 15. SWITCHING TIME vs GATE RESISTANCE

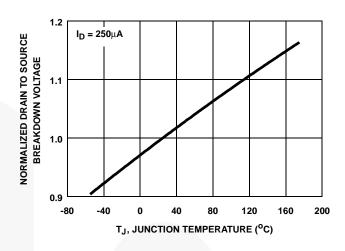
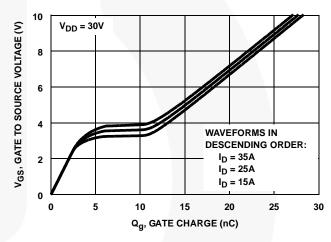


FIGURE 12. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE



NOTE: Refer to Fairchild Application Notes AN7254 and AN7260.

FIGURE 14. GATE CHARGE WAVEFORMS FOR CONSTANT GATE CURRENT

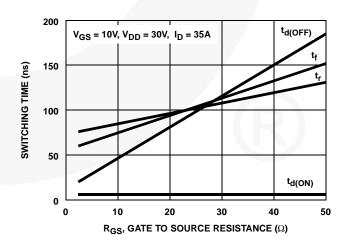


FIGURE 16. SWITCHING TIME vs GATE RESISTANCE

# **Test Circuits and Waveforms**

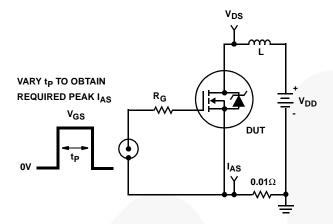


FIGURE 17. UNCLAMPED ENERGY TEST CIRCUIT

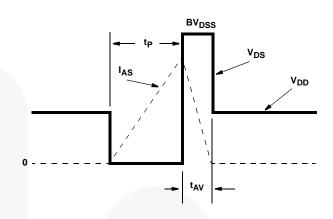


FIGURE 18. UNCLAMPED ENERGY WAVEFORMS

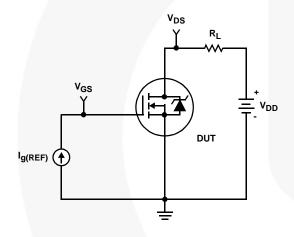


FIGURE 19. GATE CHARGE TEST CIRCUIT

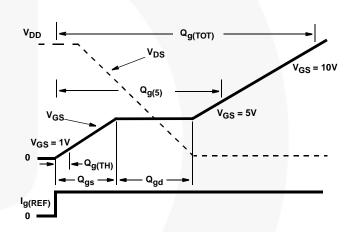


FIGURE 20. GATE CHARGE WAVEFORMS

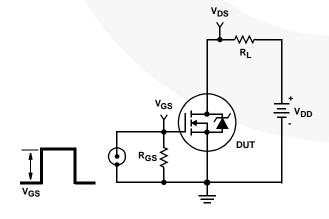


FIGURE 21. SWITCHING TIME TEST CIRCUIT

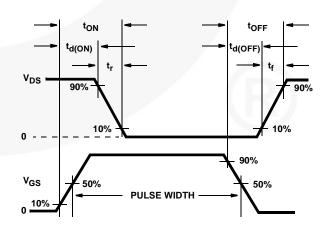
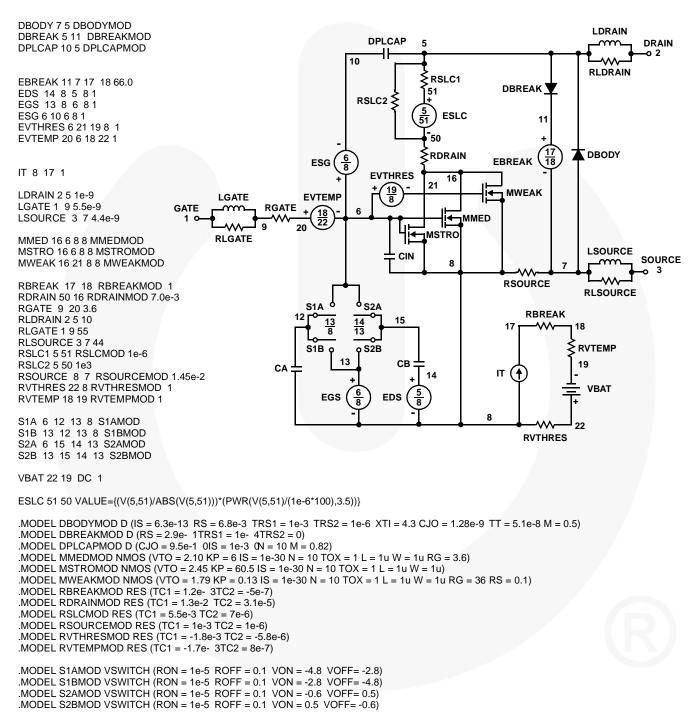


FIGURE 22. SWITCHING TIME WAVEFORM

#### **PSPICE Electrical Model**

.SUBCKT HUF76423 2 1 3; rev 7 September 1999

CA 12 8 1.46e-9 CB 15 14 1.46e-9 CIN 6 8 1.0e-9



.ENDS

NOTE: For further discussion of the PSPICE model, consult **A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options**; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank Wheatley.

#### SABER Electrical Model

```
REV 7 September 1999
template huf76423 n2,n1,n3
electrical n2,n1,n3
var i iscl
d..model dbodymod = (is = 6.3e-13, xti = 4.3, cjo = 1.28e-9, tt = 5.1e-8, m = 0.50)
d..model dbreakmod = ()
d..model dplcapmod = (cjo = 9.5e-10, is = 1e-30, n = 10, m = 0.82)
m..model mmedmod = (type=_n, vto = 2.10, kp = 6, is = 1e-30, tox = 1)
m..model mstrongmod = (type=_n, vto = 2.45, kp = 60.5, is = 1e-30, tox = 1)
m..model mweakmod = (type=_n, vto = 1.79, kp = 0.13, is = 1e-30, tox = 1)
                                                                                                                                LDRAIN
sw_vcsp..model s1amod = (ron = 1e-5, roff = 0.1, von = -4.8, voff = -2.8)
                                                                                 DPLCAP
                                                                                                                                          DRAIN
sw_vcsp..model s1bmod = (ron =1e-5, roff = 0.1, von = -2.8, voff = -4.8)
                                                                              10
sw_vcsp..model s2amod = (ron = 1e-5, roff = 0.1, von = -0.6, voff = 0.5)
                                                                                                                               RLDRAIN
sw_vcsp..model s2bmod = (ron = 1e-5, roff = 0.1, von = 0.5, voff = -0.6)
                                                                                              RSLC1
                                                                                                          RDBREAK
c.ca n12 n8 = 1.46e-9
                                                                               RSLC2 €
                                                                                                                   72
c.cb n15 n14 = 1.46e-9
                                                                                                                               RDBODY
                                                                                                ISCL
c.cin n6 n8 = 1.0e-9
                                                                                                            DBREAK _
d.dbody n7 n71 = model=dbodymod
                                                                                              RDRAIN
d.dbreak n72 n11 = model=dbreakmod
                                                                            6
8
                                                                      ESG
                                                                                                                    11
d.dplcap n10 n5 = model=dplcapmod
                                                                                  EVTHRES
                                                                                                  16
                                                                                              21
                                                                                     1<u>9</u>
8
                                                                                                              MWEAK
i.it n8 n17 = 1
                                                   LGATE
                                                                    EVTEMP
                                                                                                                               DBODY
                                                            RGATE
                                          GATE
                                                                                                              EBREAK
I.ldrain n2 n5 = 1.0e-9
                                                                                                    MMED
                                                                   20
I.lgate n1 n9 = 5.5e-9
                                                                                          I<del><</del>_MSTR
                                                  RLGATE
I.Isource n3 n7 = 4.4e-9
                                                                                                                               LSOURCE
                                                                                        CIN
                                                                                                                                         SOURCE
                                                                                                  8
m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u
m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u
                                                                                                             RSOURCE
m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u
                                                                                                                              RLSOURCE
                                                                               S2A
res.rbreak n17 n18 = 1, tc1 = 1.2e-3, tc2 = -5.0e-7
                                                                                                                  RBREAK
res.rdbody n71 n5 = 6.8e-3, tc1 = 1e-3, tc2 = 1e-6
                                                                                                              17
res.rdbreak n72 n5 = 2.9e-1, tc1 = 1e-4, tc2 = 0
                                                                                                                             RVTEMP
res.rdrain n50 n16 = 7.0e-3, tc1 = 1.3e-2, tc2 = 3.1e-5
                                                                               o S2B
res.rgate n9 n20 = 3.6
                                                                                       CB
                                                              CA
res.rldrain n2 n5 = 10
                                                                                                            ΙT
res.rlgate n1 n9 = 55
                                                                                                                               VBAT
res.rlsource n3 n7 = 44
                                                                        EGS
                                                                                    EDS
res.rslc1 n5 n51 = 1e-6, tc1 = 5.5e-3, tc2 = 7.0e-6
                                                                                                          8
res.rslc2 n5 n50 = 1e3
res.rsource n8 n7 = 1.45e-2, tc1 = 1e-3, tc2 = 1e-6
                                                                                                                 RVTHRES
res.rvtemp n18 n19 = 1, tc1 = -1.7e-3, tc2 = 8.0e-7
res.rvthres n22 n8 = 1, tc1 = -1.8e-3, tc2 = -5.8e-6
spe.ebreak n11 n7 n17 n18 = 66.0
spe.eds n14 n8 n5 n8 = 1
spe.egs n13 n8 n6 n8 = 1
spe.esg n6 n10 n6 n8 = 1
spe.evtemp n20 n6 n18 n22 = 1
spe.evthres n6 n21 n19 n8 = 1
sw_vcsp.s1a n6 n12 n13 n8 = model=s1amod
sw_vcsp.s1b n13 n12 n13 n8 = model=s1bmod
sw_vcsp.s2a n6 n15 n14 n13 = model=s2amod
sw_vcsp.s2b n13 n15 n14 n13 = model=s2bmod
v.vbat n22 n19 = dc=1
equations {
i (n51->n50) +=iscl
iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/100))** 3.5))
```

#### SPICE Thermal Model

REV 1 September 1999

HUF76423T

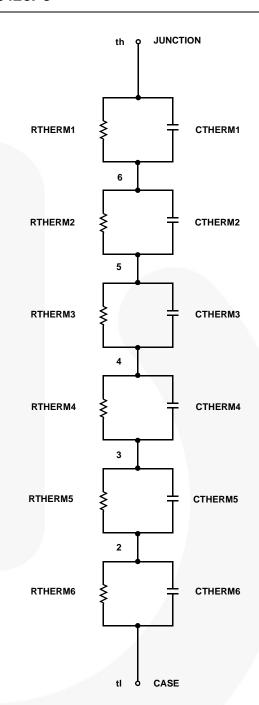
CTHERM1 th 6 1.40e-3
CTHERM2 6 5 8.30e-3
CTHERM3 5 4 7.00e-3
CTHERM4 4 3 3.20e-3
CTHERM5 3 2 1.50e-2
CTHERM6 2 tl 1.10

RTHERM1 th 6 1.20e-2
RTHERM2 6 5 2.99e-2
RTHERM3 5 4 8.43e-2
RTHERM4 4 3 4.73e-1
RTHERM5 3 2 7.14e-1
RTHERM6 2 tl 9.47e-2

### SABER Thermal Model

SABER thermal model HUF76423T

```
template thermal_model th tl thermal_c th, tl { ctherm.ctherm1 th 6 = 1.40e-3 ctherm.ctherm2 6 5 = 8.30e-3 ctherm.ctherm3 5 4 = 7.00e-3 ctherm.ctherm4 4 3 = 3.20e-3 ctherm.ctherm5 3 2 = 1.50e-2 ctherm.ctherm6 2 tl = 1.10 rtherm.rtherm1 th 6 = 1.20e-2 rtherm.rtherm2 6 5 = 2.99e-2 rtherm.rtherm3 5 4 = 8.43e-2 rtherm.rtherm4 4 3 = 4.73e-1 rtherm.rtherm5 3 2 = 7.14e-1 rtherm.rtherm6 2 tl = 9.47e-2
```





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